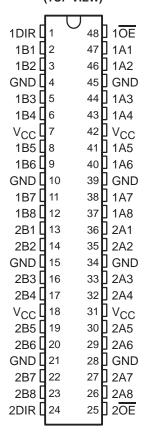
## SN54ABTH162245, SN74ABTH162245 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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- Members of the Texas Instruments
  Widebus™ Family
- A-Port Outputs Have Equivalent 25-Ω
  Series Resistors, So No External Resistors
  Are Required
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V<sub>OLP</sub> (Output Ground Bounce)
  1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-833, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and Shrink Small-Outline (DL) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

#### SN54ABTH162245 . . . WD PACKAGE SN74ABTH162245 . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)



#### description

The 'ABTH162245 devices are 16-bit noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated

The A-port outputs, which are designed to source or sink up to 12 mA, include equivalent 25- $\Omega$  series resistors to reduce overshoot and undershoot.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABTH162245 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH162245 is characterized for operation from –40°C to 85°C.



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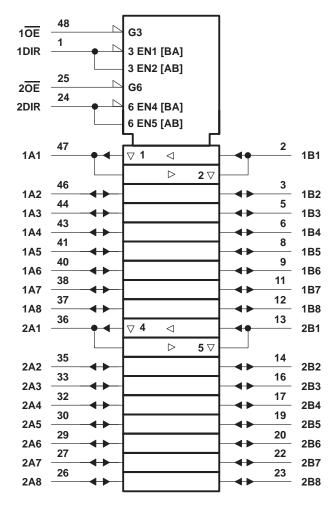


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## FUNCTION TABLE (each 8-bit section)

INP	UTS	OPERATION					
ŌĒ	DIR	OPERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
Н	X	Isolation					

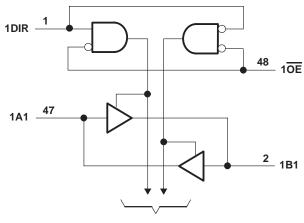
## logic symbol†

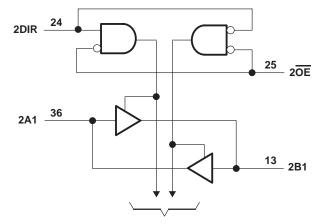


<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



#### logic diagram (positive logic)





To Seven Other Channels

To Seven Other Channels

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (except I/O ports) (see Note 1)	
Voltage range applied to any output in the high or power-off state, VO	. −0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABTH162245 (B port)	96 mA
SN74ABTH162245 (B port)	128 mA
SN54/74ABTH162245 (A port)	
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	89°C/W
DGV package	93°C/W
DL package	94°C/W
Storage temperature range, T <sub>Stg</sub>	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



## SN54ABTH162245, SN74ABTH162245 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 3)

			SN54ABTH	1162245	SN74ABTH	1162245	LINUT
			MIN	MAX	MIN	MAX	UNIT
Vсс	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2	2	2		V
V <sub>IL</sub>	Low-level input voltage		0.8		0.8	V	
VI	Input voltage	0	0 VCC		Vcc	V	
la	High lovel output ourrent	B port	2	-24		-32	mA
ЮН	High-level output current	A port	5	-12		-12	IIIA
la.	Low-level output current	B port	90	48		64	mA
IOL	Low-level output current	A port	Q'	12		12	ША
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITION	SN54	ABTH16	2245	SN74	ABTH16	2245	UNIT		
PAR	AIVICIER	TEST CONDITION	NS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP†	MAX	UNII	
VIK		$V_{CC} = 4.5 V,$				-1.2			-1.2	V	
		$V_{CC} = 5 V$ ,	$I_{OH} = -1 \text{ mA}$	2.5			2.5				
	A port		$I_{OH} = -1 \text{ mA}$	3			3				
	A poit	V <sub>CC</sub> = 4.5 V	$I_{OH} = -3 \text{ mA}$	3			3.1				
Vон			$I_{OH} = -12 \text{ mA}$				2.6			V	
VOH		$V_{CC} = 5 V$ ,	$I_{OH} = -3 \text{ mA}$	3			3			V	
	B port		$I_{OH} = -3 \text{ mA}$	2.5			2.5				
	Броп	V <sub>CC</sub> = 4.5 V	$I_{OH} = -24 \text{ mA}$	2							
			$I_{OH} = -32 \text{ mA}$				2				
	A port		$I_{OL} = 12 \text{ mA}$			0.8			0.8		
VOL	B port	V <sub>CC</sub> = 4.5 V	$I_{OL} = 48 \text{ mA}$			0.45			0.45	V	
	D port		$I_{OL} = 64 \text{ mA}$						0.55		
V <sub>hys</sub>	_				100	Ch.		100		mV	
l <sub>l</sub>	Control inputs	$V_{CC} = 5.5 \text{ V}, V_I = V_{CC} \text{ or GND}$		PREL	±1			±1	μА		
'	A or B ports	1			5	±20			±20	·	
lea e s		Voc. 45V	V <sub>I</sub> = 0.8 V	100	2		100			μА	
II(hold)		V <sub>CC</sub> = 4.5 V	V <sub>I</sub> = 2 V	-100	)		-100				
l <sub>off</sub>		$V_{CC} = 0,$ $V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5 \text{ V}$		Q					±100	μΑ	
10‡	A port	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-25		-90	-25		-100	mA	
10+	B port	VCC = 5.5 v,		-50		-180	-50		-180	IIIA	
ICEX		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50			50	μΑ	
		V <sub>CC</sub> = 5.5 V,	Outputs high			2			2		
ICC	A or B ports	$I_{O} = 0$ ,	Outputs low			32			32	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			2	2		2		
Δlcc§	Data inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND				2			2	mA	
	Control inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND				1.5			1.5		
Ci		V <sub>I</sub> = 2.5 V or 0.5 V			3			3		pF	
C <sub>io</sub>		V <sub>O</sub> = 2.5 V or 0.5 V			6			6		pF	
_				_	_	_	_	_	_	_	

 $<sup>\</sup>uparrow$  All typical values are at  $V_{CC} = 5 \text{ V}$ .



<sup>‡</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

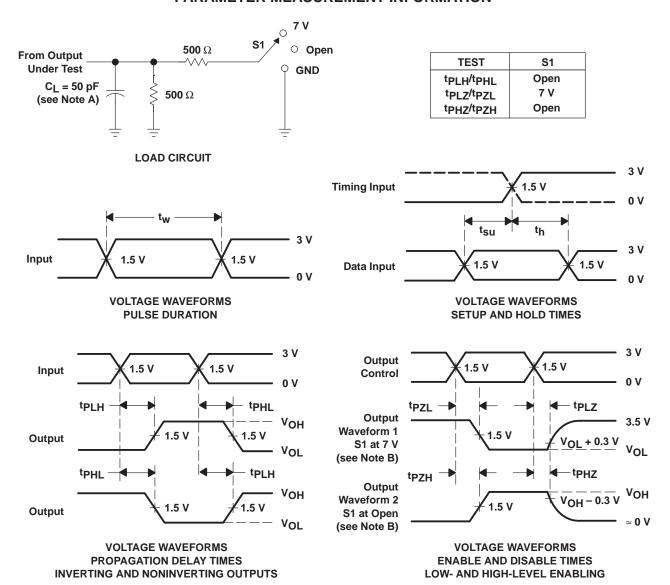
## SN54ABTH162245, SN74ABTH162245 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L$  = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>(</sub>	CC = 5 V 4 = 25°C	<b>'</b> ,	SN54ABTI	1162245	SN74ABTH	1162245	UNIT
	(1141 01)	(0011 01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	А	В	1	2.2	3.4	1	4.1	1	3.9	ns
<sup>t</sup> PHL	^	Ь	1	2.3	3.7	1	4.4	1	4.2	115
<sup>t</sup> PLH	В	А	1	2.7	4.1	1	4.9	1	4.6	no
<sup>t</sup> PHL	]	^	1.5	3.1	4.6	1.5	5.2	1.5	5.1	ns
<sup>t</sup> PZH		В	1	3.6	5.2	1 2	6.4	1	6.3	
tpZL	ŌĒ	Ь	1	3.7	5.4	15	6.5	1	6.4	ns
<sup>t</sup> PHZ	ŌĒ	В	2	4.4	5.8	2	6.4	2	6.3	
tPLZ		Р	1.5	3.3	4.7	9.5	5.6	1.5	5.2	ns
<sup>t</sup> PZH	==	Δ.	1.5	4.1	6	1.5	7.2	1.5	7.1	
<sup>t</sup> PZL	ŌĒ	Α	1.5	4.3	6.1	1.5	7.3	1.5	7	ns
<sup>t</sup> PHZ	ŌĒ	Δ.	2	4.5	6.1	2	6.8	2	6.6	
t <sub>PLZ</sub>	1 05	А	1.5	3.7	5.1	1.5	6.1	1.5	5.7	ns

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \,\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



#### PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ABTH162245DGGR	ACTIVE	TSSOP	DGG	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTH162245	Samples
SN74ABTH162245DL	ACTIVE	SSOP	DL	48	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTH162245	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABTH162245DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1

## **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABTH162245DGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0

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